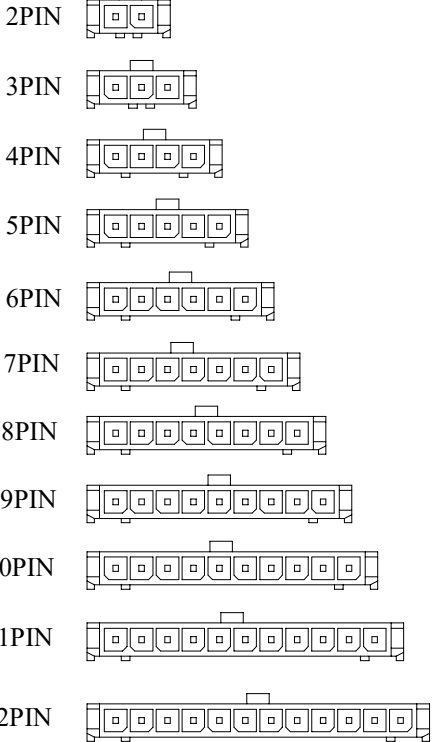
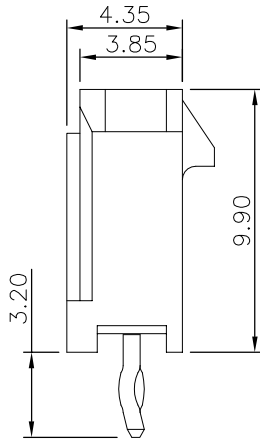
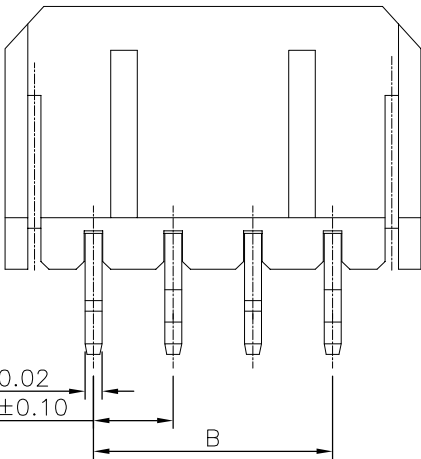
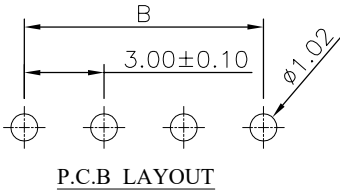
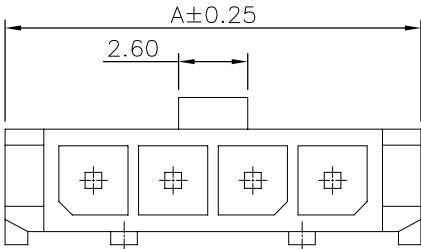


The product using material and processing must conform to the "WI-PZ-142"HSF technical standard control requirements

RoHS+HF



孔位图

NOTE:
1.MATERIAL SPECIFICATION:
1-1.HOUSING: LCP/PBT UL94V-0,BLACK
1-2.CONTACTS: BRASS
2.PLATING SPECIFICATION:
2-1.CONTACTS:
TIN PLATED OVER ALL.
3.MECHANICAL PERFORMANCE:
3-1.INSERTION FORCE: 1.00kgf/Pin MAX
3-2.REMOVAL FORCE: 0.35kgf/Pin MIN
3-3.DURABILITY: 30 CYCLES.
4.ELECTRICAL PERFORMANCE:
4-1. RATED CURRENT : 5A AC/DC
RATED VOLTAGE : 250V AC/DC
4-2.INSULATION RESISTANCE: 1000MΩ MIN
CONTACT RESISTANCE : 10mΩ(MAX.)
4-3.WITHSTANDING VOLTAGE: 1000V AC/minute
5.ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -25°C~+85°C.
6.PACKAGE SPEC: PE BAG
7.PART.NO:
C30301 F 0-1 XX 1 X X X
SERIES NO: F 0-1 XX 1 X X X
MALE FEMALE: F-FEMALE
ANGLE: 9-90°
0-180°
ROW NO: 1-SINGLE ROW
PIN Q' PY: 02~12
HOUSING:
1-LCP
2-PBT
COLOR:
A-BLACK
K-WHITE
S-NATURE
PLATING:
A-ALL AU G/F
C-BRIGHE TIN
TERMIPOINT:
1-DIP

Ordering Information & Dimensions

Circuit	Dimensions (mm)		Circuit	Dimensions (mm)	
	A	B		A	B
02	9.65	3.00	08	27.65	21.00
03	12.65	6.00	09	30.65	24.00
04	15.65	9.00	10	33.65	27.00
05	18.65	12.00	11	36.65	30.00
06	21.65	15.00	12	39.65	33.00
07	24.65	18.00			

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: C30301F0-1XX1XXX	DWG.NO: ENDE05		
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13				
				0.0±0.35	X°REF±6°							
				UNIT:mm	0.00±0.25	X°±3°	DESIGNER	Ding_bo	21.01.13			
			SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN	Ou_jian	21.01.13	TITLE: MX 3.00mm Single Row DIP 180° Wafer			REV: A0